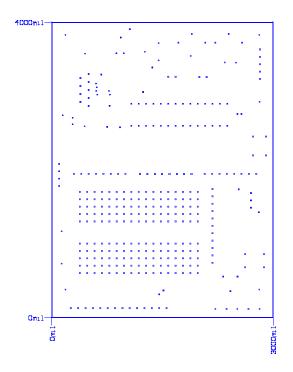
THROUGH HOLE

MARK	YTØ	DIAM		PLTD	
	9	15m1l	O. 381 mm	PTH	Round
	17	28mı1	O.7112mm	PTH	Round
*	32	35mı1	D. 889mm	PTH	Round
	2	35.433m11	D. 9mm	PTH	Round
	12	40m11	1.016mm	PTH	Round
	238	42mıl	1.0668mm	PTH	Round
۰	12	67mıl	1.7018mm	PTH	Round
•	6	70mıl	1.778mm	PTH	Round
٠	2	120mıl	3.048mm	PTH	Round
•	4 334	125mıl Total	3.175mm	нтч	Round



FABRICATION NOTES:

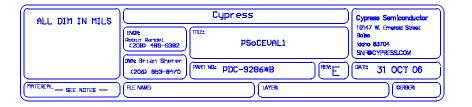
- 1. RoHS COMPLIANT CERTIFICATION OR MATERIAL DECLARATION REQUIRED.
- 2. MATERIAL:

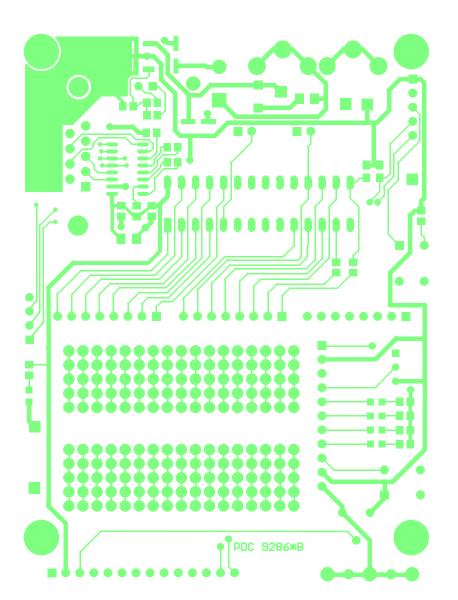
UNLESS OTHERWISE SPECIFIED IN THE STACK VIEW:

- A. NELCO 4000-11 OR IS420 OR EQUIVALENT. MATERIAL MUST CONFORM TO UL94V-D.
- B. USE 1/2 oz. COPPER FOIL FOR EXTERNAL LAYERS, 1 oz COPPER FOIL FOR INTERNAL LAYERS.
- C. OVERALL METAL THICKNESS .063 +/- 10%.
- 3. DRILLING:
 - A. DIAMETERS IN DRILL TABLE ARE FINISHED HOLE SIZES +/-.003 UNLESS SPECIFIED.
 - B. TEARDROP ALLOWED ON ENTRY OF VIA ON EVERY TRACE LAYER.
- 4. PLATING:
 - A. COPPER PLATING IN THRU-HOLES .001" min.
- 5. MARKINGS:
 - A. SILKSCREEN IN WHITE NON-CONDUCTIVE EPOXY INK ON PRIMARY SIDE OF THE BOARD OR BOTH SIDES IF APPLICABLE.
- 6. FINAL FABRICATION:
 - A. SOLDERMASK PRIMARY AND SECONDARY SIDE OF BOARD USING LIQUID PHOTOIMAGABLE MASK OVER BARE COPPER PER IPC-SM-840. SOLDERMASK COLDR ***BLUE***.
- 7. FINISH:
- A. SHALL BE ELECTROLYTIC NICKEL/GOLD. ELECTROLESS ELECTROLESS NICKEL/IMMERSION GOLD (ENIG).
- B. NICKEL THICKNESS: 10D-200 MICROINCHES/ GOLD THICKNESS 3-10 MICROINCHES.
- 8. BOARDS SHALL BE PURCHASED FROM UL RECOGNIZED VENDORS ONLY AND SHALL BE MARKED IN COPPER ON SECONDARY SIDE OF BOARD WITH VENDORS UL IDENTIFICATION FLAMMABILITY RATING (94V-O), DATE CODE (WWYY) AND RHOS COMPLIANT SYMBOL.
- 9. MANUFACTURED BOARD TO BE IN ACCORDANCE WITH PERFORMANCE STANDARD IPC-6011/6012 CLASS 2. BOARD TO BE INSPECTED PER IPC-600-A CLASS 2.
- 10. MAXIMUM BOW OR TWIST SHALL NOT EXCEED 0.007 in/in.

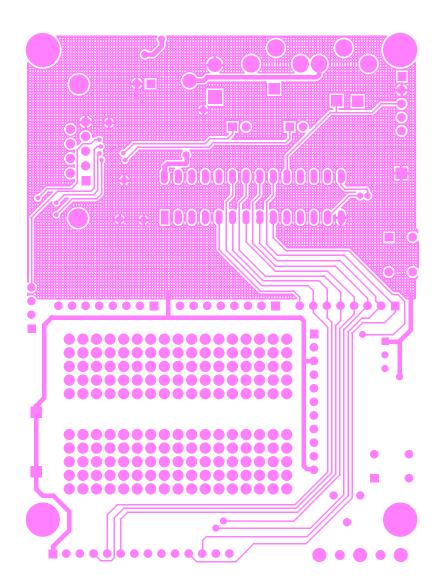
LAYER CONSTRUCTION - FILE IDENTIFICATION

DRILL AND TRIMG. GD1>

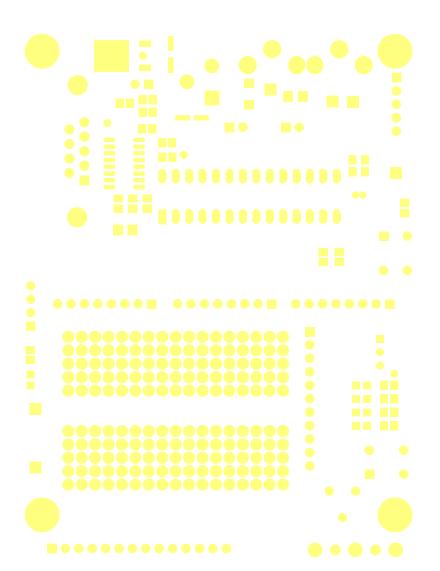




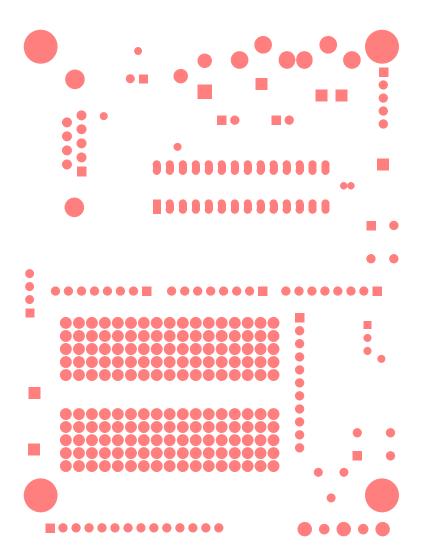
TOP COPPER (.GTL)



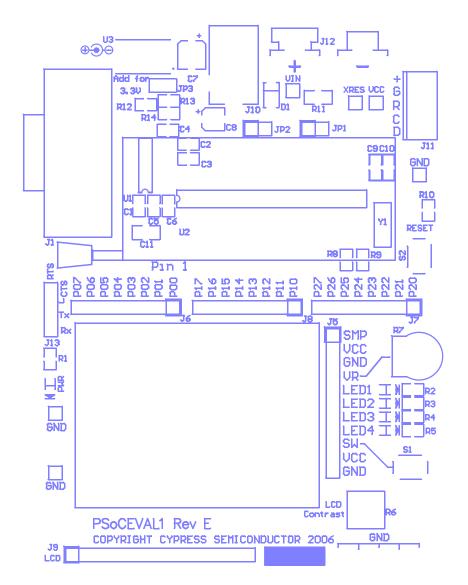
BOTTOM COPPER (.GBL)



TOP SOLDERMASK (.GTS)



BOTTOM SOLDERMASK (.GBS)



TOP OVERLAY (.GTO)